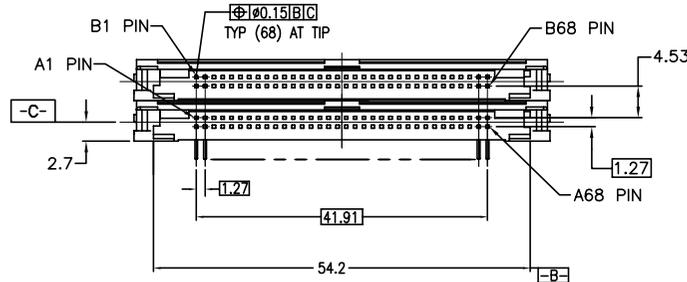
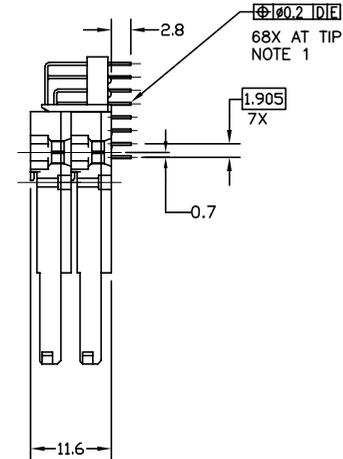
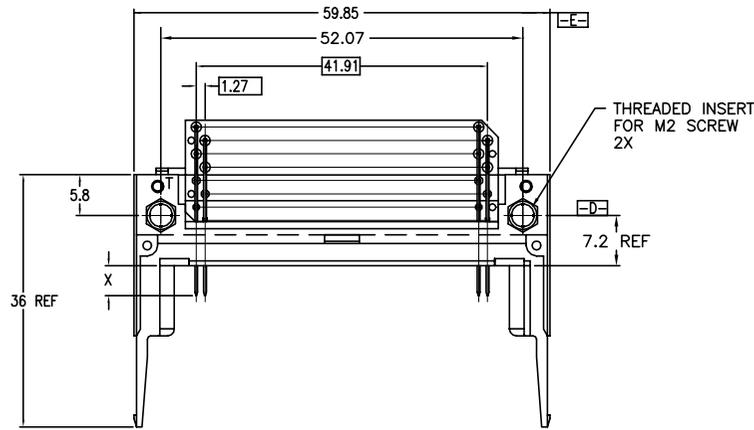


PRODUCT NO.	DIM X			MOUNTING STYLE	COLOR
	4.25±0.1	3.5±0.1	5.0±0.1		
92821-000	OTHERS	36,67	1,17,34 35,51,68	TOP W\O LOCATOR	BLACK
92821-000LF	OTHERS	36,67	1,17,34 35,51,68	TOP W\O LOCATOR	BLACK

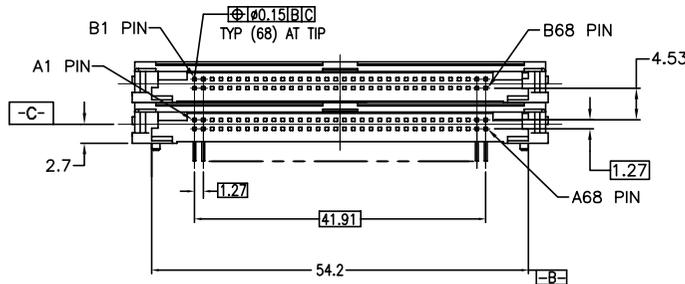
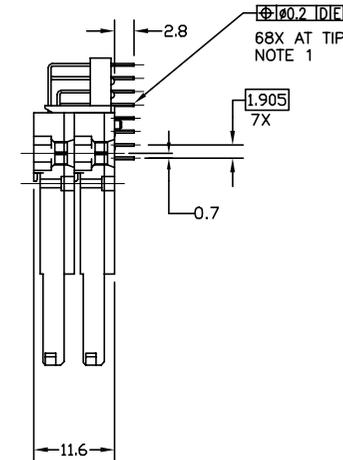
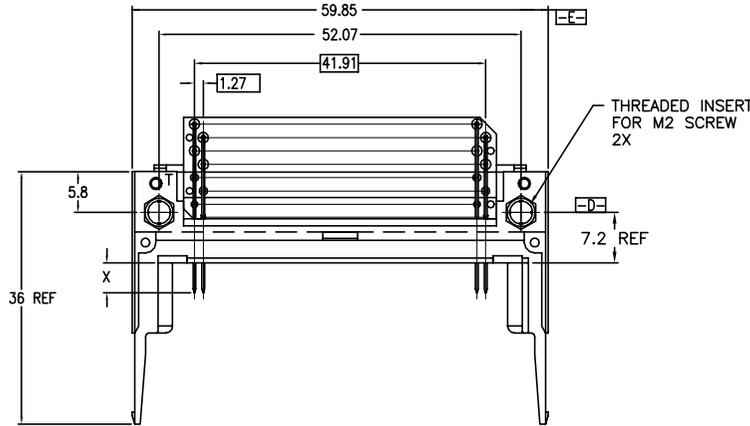


NOTES:

- TRUE POSITION IS A FREE GRID TO THE PIN PATTERN ITSELF.
- SEE TA-946 FOR PCB LAYOUT.
- MATERIAL:  
PLASTIC: HIGH TEMPERATURE THERMOPLASTIC UL94V-0 BLACK  
PIN: COPPER ALLOY
- FINISH (PIN):  
UNDER PLATING: 0.5 µM MIN. Ni  
CONTACT AREA: 0.076 µM MIN. GOLD  
SOLDER AREA: 2.5 µM MIN. Sn-Pb OR 2.5µM MIN PURE Sn FOR -XXXLF
- PRODUCT SPEC: 110-263

mat'l. code		surface <input checked="" type="checkbox"/> ISD1302		tolerance <input checked="" type="checkbox"/> ISO406 <input type="checkbox"/> ISO1101		projection <input checked="" type="checkbox"/>		product family PCMCIA	
l'tecn nodr		date		tolerances unless otherwise specified		MM		title	
L	ELX-N-007962	ZK	11/01/11	angle	0.X±0.3	scale 2:1		68 POSITION DOUBLE DECK	
M	ELX-N-011432	ZK	04/23/12	0°±2'	0.XX±0.13			TYPE-123 EJECT HEADER	
F	V41226	RDS	08/18/94		0.XXX±0.05			dwg no	
G	V41439	RDS	09/30/94	dr	D.SHEAFFER	06/09/93	sheet 1 of 7		size
H	T40309	MSC	02/02/95	engr	D.BRANN	06/09/93	92821		A4
J	V12164	TFG	08/17/01	chr	D.BRANN	06/09/93	type		Product Customer Drawing
K	N05-0052	WB	02/25/05	appd	D.BRANN	06/09/93			
sheet index	revision	M	M	M	M	M	M		
	sheet	1	2	3	4	5	6	7	

PRODUCT NO.	DIM X			MOUNTING STYLE	COLOR
	4.25±0.1	3.5±0.1	5.0±0.1		
92821-003	OTHERS	36,67	1,17,34 35,51,68	TOP W\LOCATOR	BLACK
92821-003LF	OTHERS	36,67	1,17,34 35,51,68	TOP W\LOCATOR	BLACK

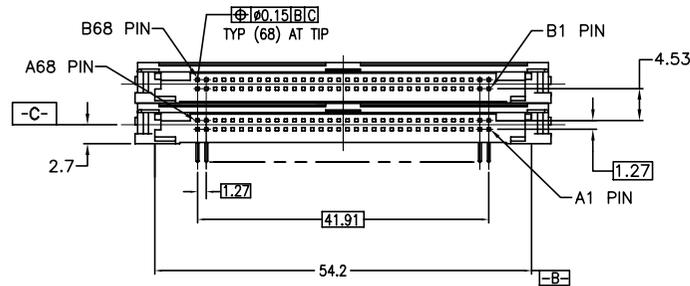
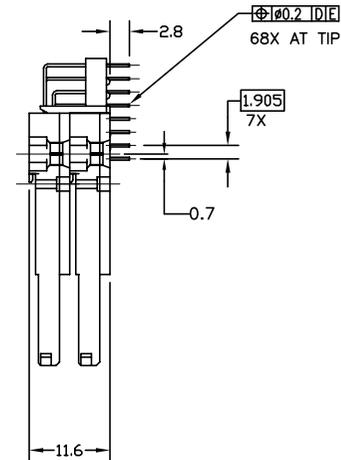
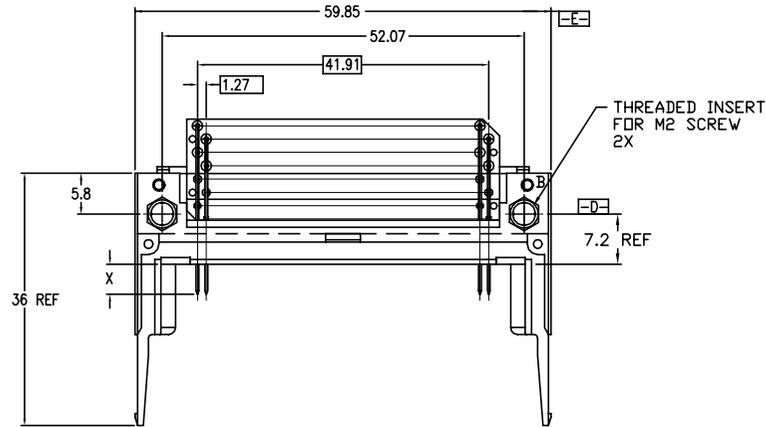


NOTES:

- TRUE POSITION IS A FREE GRID TO THE PIN PATTERN ITSELF.
- SEE TA-946 FOR PCB LAYOUT.
- MATERIAL:  
PLASTIC: HIGH TEMPERATURE THERMOPLASTIC UL94V-0 BLACK  
PIN: COPPER ALLOY
- FINISH (PIN):  
UNDER PLATING: 0.5 μM MIN. Ni  
CONTACT AREA: 0.076 μM MIN. GOLD  
SOLDER AREA: 2.5 μM MIN. Sn-Pb OR 2.5μM MIN PURE Sn FOR -XXXLF
- PRODUCT SPEC:110-263

mat'l. code	surface ISO1302	tolerance ISO406 ISO1101	projection MM	product family PCMCIA
trtecn nodr	date	tolerances unless otherwise specified	scale:2:1	title 68 POSITION DOUBLE DECK TYPE-123 EJECT HEADER
M		angle 0°±2'		dwg no 92821
		dr D.SHEAFFER 06/09/93		sheet 2 of 7
		engr D.BRANN 06/09/93		size A4
		chr D.BRANN 06/09/93		type Product Customer Drawing
		appd D.BRANN 06/09/93		
sheet index	revision sheet			

PRODUCT NO.	DIM X			MOUNTING STYLE	COLOR
	4.25±0.1	3.5±0.1	5.0±0.1		
92821-500	OTHERS	36,67	1,17,34 35,51,68	BOTTOM W\O LOCATOR	NATURAL
92821-500LF	OTHERS	36,67	1,17,34 35,51,68	BOTTOM W\O LOCATOR	NATURAL

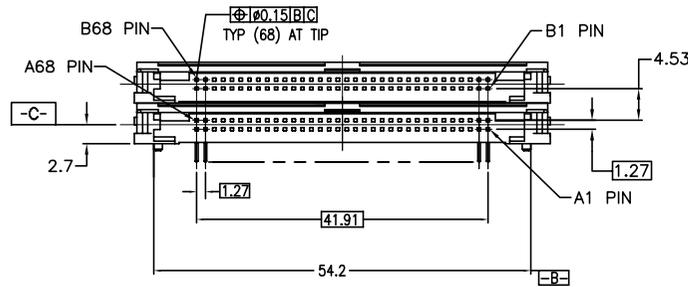
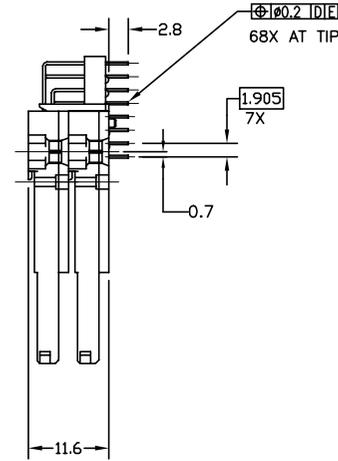
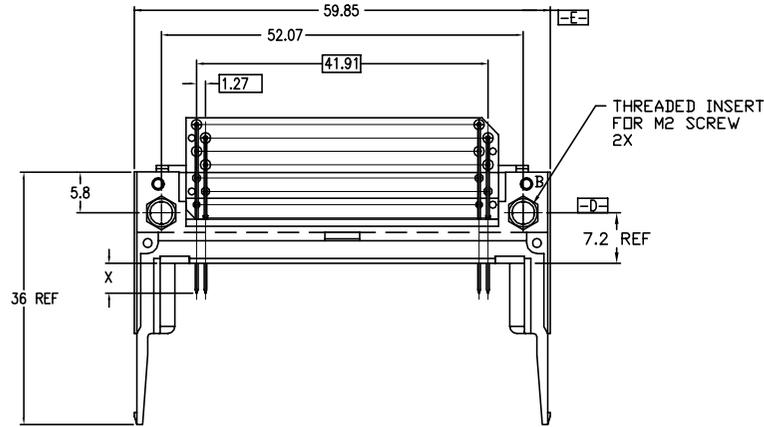


NOTES:

- TRUE POSITION IS A FREE GRID TO THE PIN PATTERN ITSELF.
- SEE TA-946 FOR PCB LAYOUT.
- MATERIAL:  
PLASTIC: HIGH TEMPERATURE THERMOPLASTIC UL94V-0 BLACK  
PIN: COPPER ALLDY
- FINISH (PIN):  
UNDER PLATING: 0.5 µM MIN. NI  
CONTACT AREA: 0.076 µM MIN. GOLD  
SOLDER AREA: 2.5 µM MIN. Sn-Pb OR 2.5µM MIN PURE Sn FOR -XXXLF
- PRODUCT SPEC: 110-263

mat'l. code	surface ISO1302 ✓	tolerance ISO406 ISO1101	projection MM	product family PCMCIA
l trechn nodr	date	tolerances unless other	scale 2:1	title 68 POSITION DOUBLE DECK TYPE-123 EJECT HEADER
M		angle 0°±2'		dwg no 92821
		dr D.SHEAFFER 06/09/93		sheet 3 of 7
		engr D.BRANN 06/09/93		size A4
		chr D.BRANN 06/09/93		type Product Customer Drawing
		appd D.BRANN 06/09/93		
sheet index	revision sheet			

PRODUCT NO.	DIM X			MOUNTING STYLE	COLOR
	4.25±0.1	3.5±0.1	5.0±0.1		
92821-503	OTHERS	36,67	1,17,34 35,51,68	BOTTOM W\LOCATOR	NATURAL
92821-503LF	OTHERS	36,67	1,17,34 35,51,68	BOTTOM W\LOCATOR	NATURAL

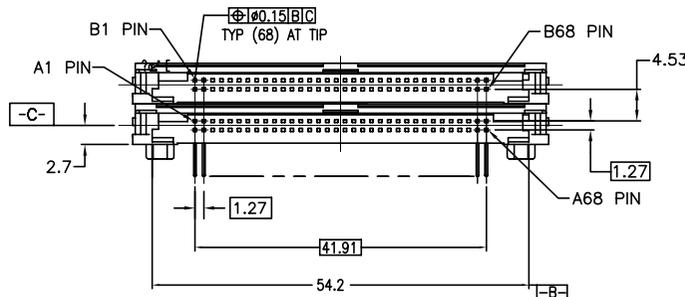
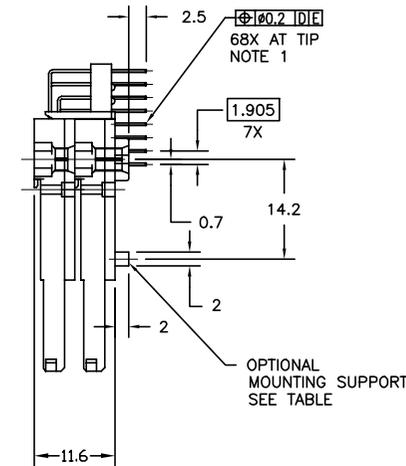
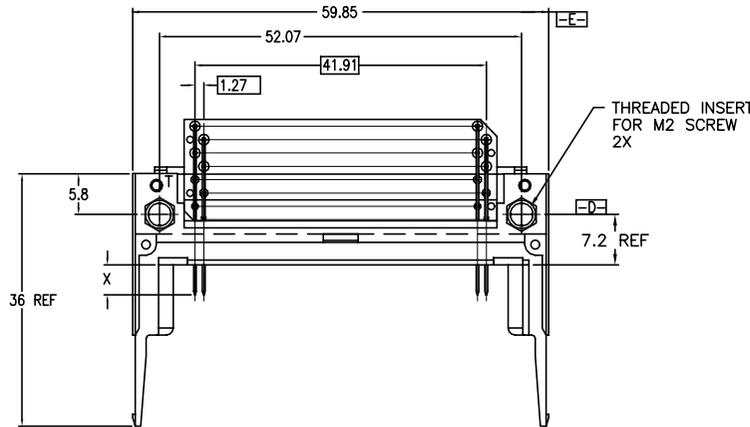


NOTES:

- TRUE POSITION IS A FREE GRID TO THE PIN PATTERN ITSELF.
- SEE TA-946 FOR PCB LAYOUT.
- MATERIAL:  
PLASTIC: HIGH TEMPERATURE THERMOPLASTIC UL94V-0 BLACK  
PIN: COPPER ALLOY
- FINISH (PIN):  
UNDER PLATING: 0.5 µM MIN. Ni  
CONTACT AREA: 0.076 µM MIN. GOLD  
SOLDER AREA: 2.5 µM MIN. Sn-Pb OR 2.5µM MIN PURE Sn FOR -XXXLF
- PRODUCT SPEC: 110-263

mat'l. code	surface ISO1302	tolerance ISO406 ISO1101	projection MM	product family PCMCIA
l'tecn nodr	date	tolerances unless otherwise specified	scale 2:1	title 68 POSITION DOUBLE DECK TYPE-123 EJECT HEADER
M		angle 0°±2'		dwg no 92821
		dr D.SHEAFFER 06/09/93		sheet 4 of 7
		engr D.BRANN 06/09/93		size A4
		chr D.BRANN 06/09/93		type Product Customer Drawing
		appd D.BRANN 06/09/93		
sheet index	revision sheet			

PRODUCT NO.	DIM X			MOUNTING STYLE	COLOR	MOUNTING STYLE
	4.25±0.1	3.5±0.1	5.0±0.1			
92821-040	OTHERS	36,67	1,17,34 35,51,68	TOP W\O LOCATOR	BLACK	WITH
92821-080	OTHERS	36,67	1,17,34 35,51,68	TOP W\O LOCATOR	BLACK	WITHOUT
92821-040LF	OTHERS	36,67	1,17,34 35,51,68	TOP W\O LOCATOR	BLACK	WITH
92821-080LF	OTHERS	36,67	1,17,34 35,51,68	TOP W\O LOCATOR	BLACK	WITHOUT

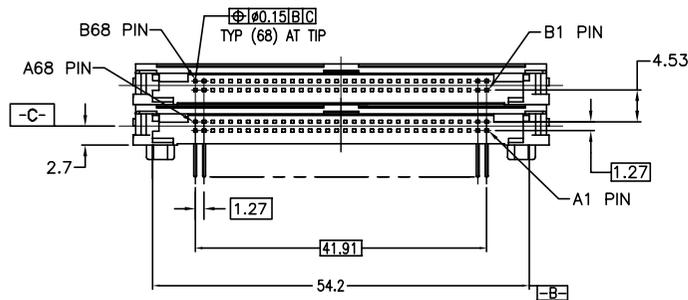
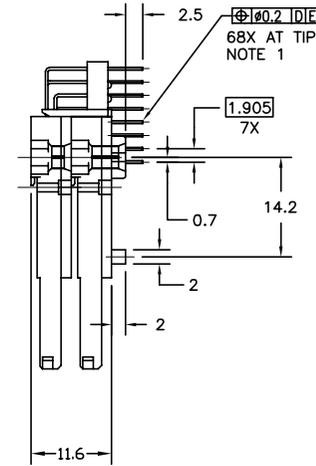
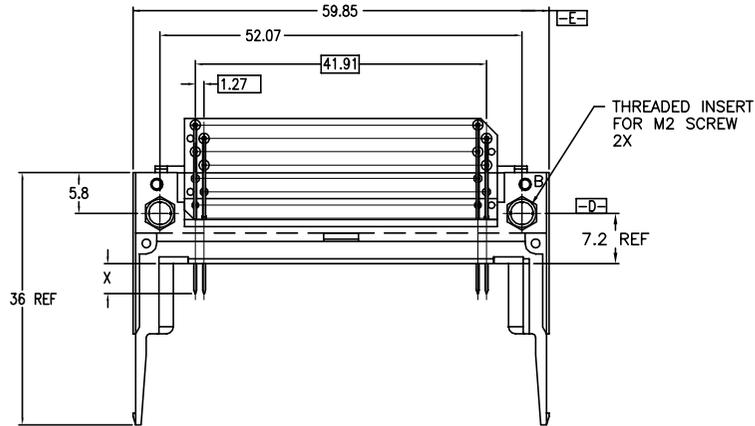


NOTES:

- TRUE POSITION IS A FREE GRID TO THE PIN PATTERN ITSELF.
- SEE TA-946 FOR PCB LAYOUT.
- MATERIAL:  
PLASTIC: HIGH TEMPERATURE THERMOPLASTIC UL94V-0 BLACK  
PIN: COPPER ALLOY
- FINISH (PIN):  
UNDER PLATING: 0.5 µM MIN. Ni  
CONTACT AREA: 0.076 µM MIN. GOLD  
SOLDER AREA: 2.5 µM MIN. Sn-Pb OR 2.5µM MIN PURE Sn FOR -XXXLF
- PRODUCT SPEC: 110-263

mat'l. code	surface	tolerance	projection	product family
	ISO1302	ISO406 ISO1101		PCMCIA
l trechn nodr date	tolerances unless otherwise specified		MM	68 POSITION DOUBLE DECK TYPE-123 EJECT HEADER
M	angle	0.X±0.3 0.XX±0.13 0.XXX±0.05	scale 2:1	dwg no 92821 sheet 5 of 7 size A4
	dr	D.SHEAFFER 06/09/93		type Product Customer Drawing
	enr	D.BRANN 06/09/93		
	chr	D.BRANN 06/09/93		
	appd	D.BRANN 06/09/93		
sheet index	revision sheet			

PRODUCT NO.	DIM X			MOUNTING STYLE	COLOR
	4.25±0.1	3.5±0.1	5.0±0.1		
92821-540	OTHERS	36,67	1,17,34 35,51,68	BOTTOM W\O LOCATOR	NATURAL
92821-540LF	OTHERS	36,67	1,17,34 35,51,68	BOTTOM W\O LOCATOR	NATURAL

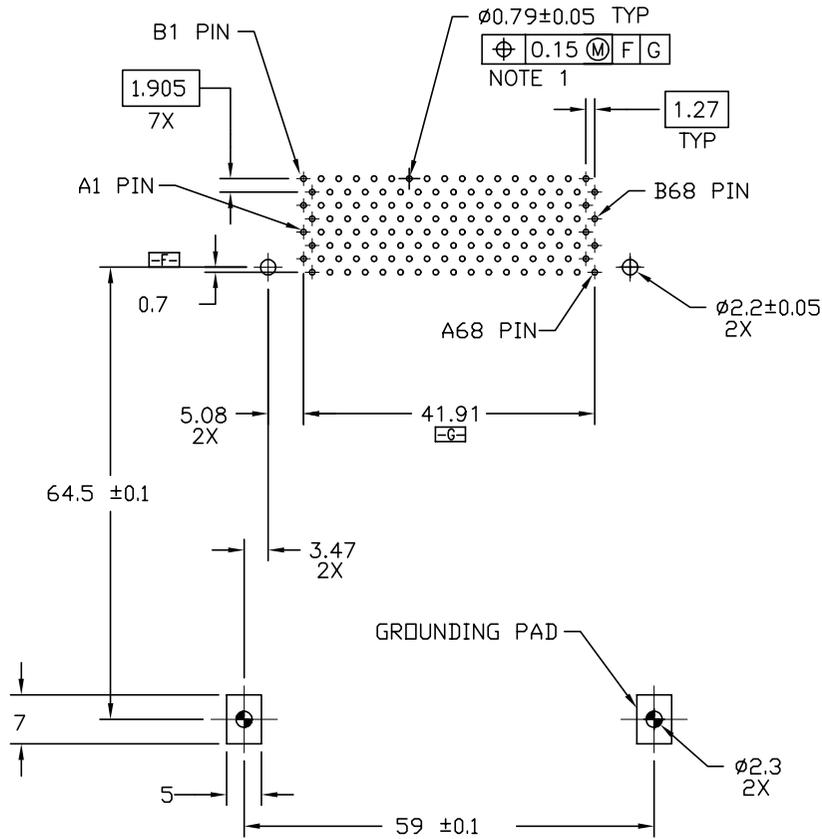


NOTES:

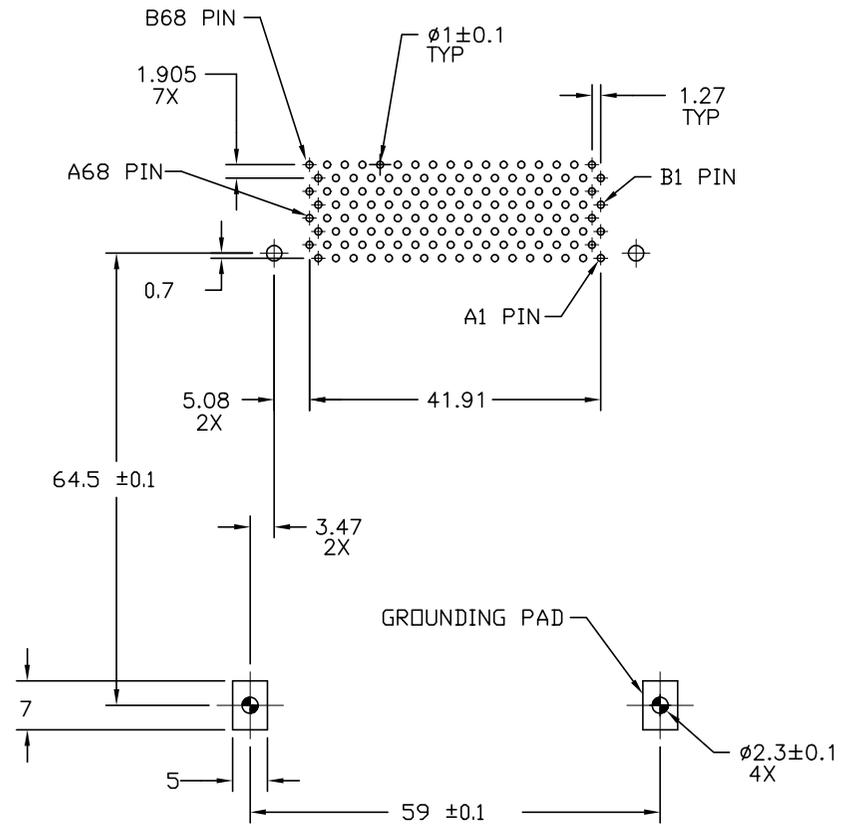
- TRUE POSITION IS A FREE GRID TO THE PIN PATTERN ITSELF.
- SEE TA-946 FOR PCB LAYOUT.
- MATERIAL:  
PLASTIC: HIGH TEMPERATURE THERMOPLASTIC UL94V-0 BLACK  
PIN: COPPER ALLOY
- FINISH (PIN):  
UNDER PLATING: 0.5 µm MIN. Ni  
CONTACT AREA: 0.076 µm MIN. GOLD  
SOLDER AREA: 2.5 µm MIN. Sn-Pb OR 2.5µm MIN PURE Sn FOR -XXXLF
- PRODUCT SPEC: 110-263

mat'l. code	surface	tolerance	projection	product family
	ISO1302	ISO406 ISO1101		PCMCIA
l trechn nodr date	tolerances unless otherwise specified		MM	68 POSITION DOUBLE DECK TYPE-123 EJECT HEADER
M	angle	0.X±0.3 0.XX±0.13 0°±2'	scale 2:1	dwg no 92821 sheet 6 of 7 size A4
	dr	D.SHEAFFER 06/09/93		type Product Customer Drawing
	engr	D.BRANN 06/09/93		
	chr	D.BRANN 06/09/93		
	appd	D.BRANN 06/09/93		
sheet index	revision sheet			

SEE SH. 1&2



RECOMMENDED P.C.B. LAYOUT  
FOR TOP MOUNTED  
SCALE 2/1



RECOMMENDED P.C.B. LAYOUT  
FOR BOTTOM MOUNTED  
SCALE 2/1

mat'l. code	surface ISO1302	tolerance ISO406 ISO1101	projection MM	product family PCMCIA
trnecn nodr	date	tolerances unless otherwise specified	MM	title 68 POSITION DOUBLE DECK TYPE-123 EJECT HEADER
M		angle 0°±2'	scale 2:1	dwg no 92821
		dr D.SHEAFFER 06/09/93		sheet 7 of 7
		enr D.BRANN 06/09/93		size A4
		chr D.BRANN 06/09/93		type Product Customer Drawing
		appd D.BRANN 06/09/93		
sheet index	revision sheet			